

Solder wire Sn99Ag0.3Cu0.7, 1.0 mm, flux type 3064, lead-free, 1 kg



Tamura Elsold's solder wire, made from the lead-free Sn99Ag0.3Cu0.7 alloy, is ideal for demanding soldering applications in electronics manufacturing, maintenance, and repair. The high-quality tin-silver-copper alloy ensures reliable, electrically conductive, and mechanically robust solder joints. Thanks to the integrated flux type 3064, even surfaces that are difficult to wet—such as nickel, brass, or bronze—can be soldered safely and cleanly.

With a wire diameter of 1.0 mm, the solder wire offers optimal control for hand soldering and repair applications. The included ROM1-class flux (F-SW26) ensures excellent wetting and promotes the formation of clean, durable solder joints. Thanks to its lead-free formulation, the solder meets modern environmental and manufacturing requirements and is suitable for professional use in electronics production.

- Lead-free solder wire with Sn99Ag0.3Cu0.7 alloy

- 1.0 mm wire diameter for precise application
- Flux type 3064 for optimal wetting
- Also suitable for nickel, brass, and bronze
- ROM1 / F-SW26 Flux classification
- Reliable electrical and mechanical connections
- Ideal for electronics manufacturing, repair, and service
- 1 kg spool for professional continuous use

Item no.	WL93261
Model	Flussmitteltyp 3064 (bleifrei)
Manufacturer	TAMURA ELSOLD
Manufacturer article no.	RÖLOT0093
GPSR manufacturer data	TAMURA DEUTSCHLAND GmbH Hüttenstraße 1 DE-38871 Ilsenburg www.tamura-elsold.de
Sales unit	1 rolls
Content unit	1 rolls
Detail content unit	1 kg
Incl. battery	no
Flux class	1.1.2, F-SW26, ROM1
Alloy	Sn99Ag0,3Cu0,7
Flux type	3064
Flux content	3.3 %
Classification	• ROM1 • 1.1.2 • F-SW26
Wire diameter	1 mm
Alloy	Sn99Ag0,3Cu0,7
Lead-free/lead-containing	lead free
ESD compliant	no